

**AMENDMENTS TO THE CLAIMS**

The claims in this listing will replace all prior versions, and listings, of claims in the application.

1. (Original) A method of manufacturing an optical recording medium by forming a resin layer on a first surface of a disc-like substrate and then forming a center hole that passes through the disc-like substrate and the resin layer,

wherein the center hole is formed by forming, in the resin layer, a circular cut with a larger diameter than the center hole so as to surround a formation position of the center hole and then pressing a punching blade for forming the center hole into the disc-like substrate from a second surface side of the disc-like substrate.

2. (Original) A method of manufacturing an optical recording medium according to Claim 1,

wherein the cut is formed in the resin layer with a depth that reaches the first surface.

3. (Original) A method of manufacturing an optical recording medium according to Claim 1,

wherein a substrate pressing jig is placed in contact with the second surface of the disc-like substrate and the contact is maintained while the cut is formed in the resin layer.

4. (Original) A method of manufacturing an optical recording medium according to Claim 1,

wherein a resin layer pressing jig is placed in contact with the resin layer and the contact is maintained while the center hole is formed by pressing the punching blade into the disc-like substrate.

5. (Original) A method of manufacturing an optical recording medium according to Claim 4,

wherein the cut is formed in the resin layer by placing the resin layer pressing jig, in which a cut forming blade is formed with a height in accordance with a depth of the cut, in contact with the resin layer.

6. (Original) A method of manufacturing an optical recording medium according to Claim 1,

wherein the center hole is formed by pressing the punching blade into the disc-like substrate while the punching blade is vibrated by ultrasound.

7. (Original) A method of manufacturing an optical recording medium according to Claim 1,

wherein when the disc-like substrate is molded, a concave part with an equal diameter or a substantially equal diameter to the center hole is formed at the formation position of the center hole in the second surface of the disc-like substrate.

8-14 (Canceled).